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# Datasheet

## Emerging Display

**ET043003DM6**

DY-01-001

EXAMINED BY :  <i>Yung Chang Hu</i>	<b>EMERGING DISPLAY</b>  TECHNOLOGIES CORPORATION	FILE NO . CAS-0006877
APPROVED BY:		ISSUE : MAY.20, 2009
<i>David Chang</i>		TOTAL PAGE : 25
		VERSION : 1

CUSTOMER                      ACCEPTANCE                      SPECIFICATIONS

MODEL NO. :

ET043003DM6

(GP)

FOR MESSRS :

\_\_\_\_\_

CUSTOMER'S APPROVAL

DATE :

\_\_\_\_\_

BY :

\_\_\_\_\_

EMERGING DISPLAY  
TECHNOLOGIES CORPORATION

MODEL NO.	VERSION	PAGE
ET043003DM6	1	0-1

RECORDS OF REVISION	DOC . FIRST ISSUE	MAY.20, 2009
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DATE	REVISED PAGE NO.	SUMMARY

MODEL NO.	VERSION	PAGE
ET043003DM6	1	0-2

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1. GENERAL SPECIFICATIONS

1.1 APPLICATION NOTES FOR CONTROLLER/DRIVER  
PLEASE REFER TO :

HIMAX HX8257-A

1.2 MATERIAL SAFETY DESCRIPTION

ASSEMBLIES SHALL COMPLY WITH EDT GREEN PRODUCT (GP) REQUIREMENTS, INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD, MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED BIPHENYLS (PBB), POLYBROMINATED DIPHENYL ETHERS (PBDE), POLYCHLORINATED BIPHENYLS (PCB) CATEGORY, POLYCHLORINATED NAPHTHALENE (PCN) CATEGORY, POLYCHLORINATED TERPHENYLS (PCT) CATEGORY, CHLORINATED PARAFFINS (CP) CATEGORY, TRIBUTHYL TIN CATEGORY / TRIPHENYL TIN CATEGORY, ASBESTOS, SPECIFIC AZO COMPOUNDS, FORMALDEHYDE, POLYVINYL CHLORIDE (PVC) AND PVC BLENDS, OTHER BROMINATED ORGANIC COMPOUNDS AND OTHER CHLORINATED ORGANIC COMPOUNDS.

2. MECHANICAL SPECIFICATIONS

- (1) DIAGONALS ----- 4.3 inch
- (2) NUMBER OF DOTS ----- 480W \* (RGB) \* 272H DOTS
- (3) MODULE SIZE ----- 105.5W \* 67.2H \* 3.95D mm  
(WITHOUT & FPC)
- (4) EFFECTIVE AREA ----- 98.7W \* 56.4H mm
- (5) ACTIVE AREA ----- 95.04W \* 53.856H mm
- (6) DOT SIZE ----- 0.066W \* 0.198H mm
- (7) PIXEL PITCH ----- 0.198W \* 0.198H mm
- (8) LCD TYPE ----- TFT , TRANSMISSIVE
- (9) COLOR ----- 16.7M
- (10) VIEWING DIRECTION ----- 6 O'CLOCK
- (11) BACK LIGHT ----- LED , COLOR : WHITE
- (12) INTERFACE MODE ----- RGB(24 BIT ) PARALLEL

### 3. ABSOLUTE MAXIMUM RATINGS

#### 3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER VOLTAGE	VCC-VSS	-0.3	4.0	V	VSS=0
LED BACKLIGHT POWER DISSIPATION	PO	—	1296	mW	
LED BACKLIGHT FORWARD CURRENT	IF	—	60	mA	

#### 3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS.

I T E M	OPERATING		STORAGE		REMARK
	MIN.	MAX.	MIN.	MAX.	
AMBIENT TEMPERATURE	-20°C	70°C	-30°C	80°C	NOTE ( 1 ) , ( 2 )
HUMIDITY	NOTE ( 3 )		NOTE ( 3 )		WITHOUT CONDENSATION
VIBRATION	—	3.92 m/s <sup>2</sup> ( 0.4 G )	—	19.6 m/s <sup>2</sup> ( 2.0 G )	10~55Hz X, Y, Z, EACH 2HRS
SHOCK	—	58.8 m/s <sup>2</sup> ( 6 G )	—	980 m/s <sup>2</sup> ( 100 G )	6 m SECONDS XYZ DIRECTIONS 3 TIMES EACH
CORROSIVE GAS	NOT ACCEPTABLE		NOT ACCEPTABLE		

NOTE ( 1 ) : Ta AT -30°C : 48HRS MAX .

80°C : 168HRS MAX .

NOTE ( 2 ) : BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT  
TEMPERATURE THIS PHENOMENON IS REVERSIBLE .

NOTE ( 3 ) : Ta ≤ 60°C : 90%RH MAX (96HRS MAX).

Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY  
OF 90%RH AT 60°C (96HRS MAX).

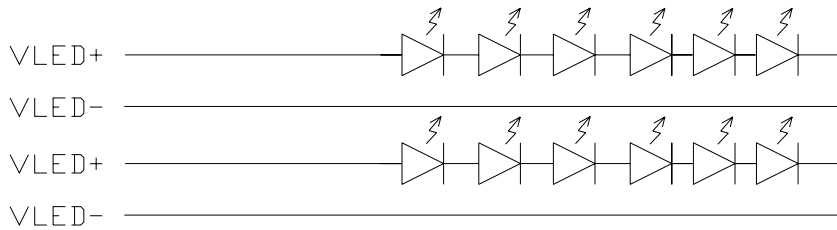
4. ELECTRICAL CHARACTERISTICS

Ta = 25 °C

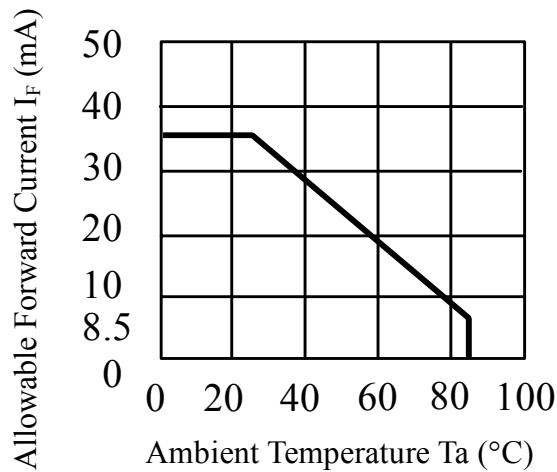
PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY	VCC-VSS	—	3.0	3.3	3.6	V	
OPERATING CURRENT	ICC	—	—	17	22	mA	
INPUT LOW VOLTAGE	V <sub>IL</sub>	—	0	—	0.2*VCC	V	NOTE (1)
INPUT HIGH VOLTAGE	V <sub>IH</sub>	—	0.8*VCC	—	VCC	V	NOTE (1)
POWER SUPPLY FOR LED BACKLIGHT	VF	IF = 36mA	17.4	19.8	21.6	V	NOTE (2)
LED LIFE TIME	—	—	(30000)	(40000)	—	HRS	

NOTE ( 1 ) : APPLIED TO TERMINALS R0~R7 , G0~G7 , B0~B7 , CLK , DISP , HS , VS.

NOTE ( 2 ) : INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT



NOTE ( 3 ) : LED BACKLIGHT AMBIENT TEMP. VS. FORWARD CURRENT.





## 5. TIMING CHART

THE HX8257-A BOTH SUPPORTS DE MODE AND SYNC MODE TIMING. THE MODE WAS DECIDED BY DE SIGNAL INTERNALLY. WHEN DE IS PULLED LOW, THE HX8257-A USES HS+VS FOR TIMING CONTROL AND THIS TIMING MODE IS SYNC MODE. WHEN DE IS PULLED HIGH FOR ACTIVE DATA AND PULLED LOW FOR BLANKING DATA, THE HX8257-A USES DE FOR TIMING CONTROL AND THIS TIMING MODE IS DE MODE. THE DETAIL TIMING CHART SHOWED BELOW.

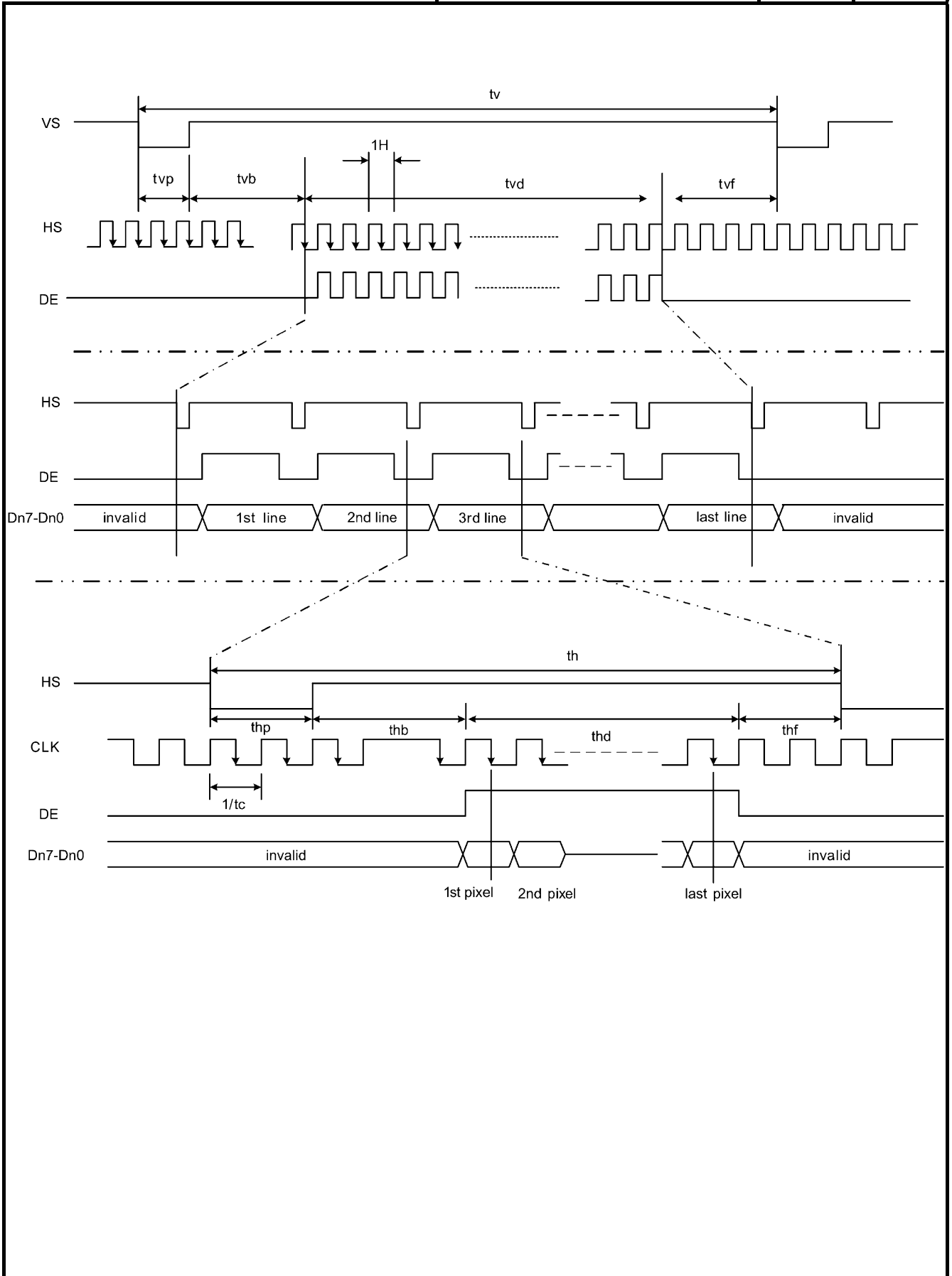
### 5.1 PARALLEL RGB INPUT TIMING REQUIREMENT

480RGBx272 ,  $T_A=25^{\circ}\text{C}$  ,  $V_{CC}=3.0\text{V}$  to  $3.6\text{V}$  ,  $V_{SS}=0\text{V}$

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
CLOCK CYCLE	$f_{\text{CLK}}^{(1)}$	—	9	15	MHz
HSYNC CYCLE	$1/t_h$	—	17.14	—	KHz
VSYNC CYCLE	$1/t_v$	—	59.94	—	Hz
HORIZONTAL SIGNAL					
HORIZONTAL CYCLE	$t_h$	525	525	605	CLK
HORIZONTAL DISPLAY PERIOD	$t_{hd}$	480	480	480	CLK
HORIZONTAL FRONT PORCH	$t_{hf}$	2	2	82	CLK
HORIZONTAL PULSE WIDTH	$t_{hp}^{(2)}$	2	41	41	CLK
HORIZONTAL BACK PORCH	$t_{hb}^{(2)}$	2	2	41	CLK
VERTICAL SIGNAL					
VERTICAL CYCLE	$t_v$	285	286	399	$H^{(1)}$
VERTICAL DISPLAY PERIOD	$t_{vd}$	272	272	272	$H^{(1)}$
VERTICAL FRONT PORCH	$t_{vf}$	1	2	227	$H^{(1)}$
VERTICAL PULSE WIDTH	$t_{vp}^{(2)}$	1	10	11	$H^{(1)}$
VERTICAL BACK PORCH	$t_{vb}^{(2)}$	1	2	11	$H^{(1)}$

NOTE : 1.Unit:  $\text{CLK}=1/f_{\text{CLK}}$  ,  $H=t_h$ ,

2. It is necessary to keep  $t_{vp}+t_{vb}=12$  and  $t_{hp}+t_{hb}=43$  in sync mode. DE mode is unnecessary to keep it.

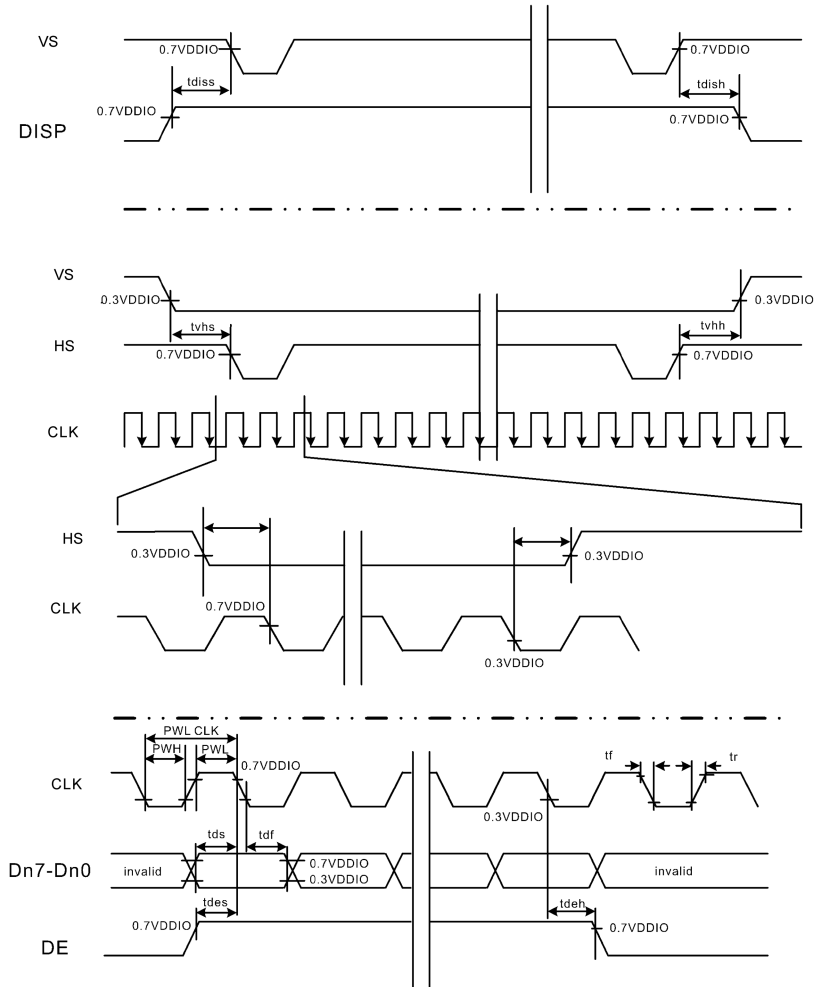


5.2 INPUT SETUP TIMING REQUIREMENT

$T_A=25^{\circ}C$ ,  $V_{CC}=3.0V$  to  $3.6V$ ,  $V_{SS}=0V$ ,  $t_r^{(1)} = t_f^{(1)} = 2ns$

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
DISP SETUP TIME	$t_{diss}$	10	—	—	ns
DISP HOLD TIME	$t_{dish}$	10	—	—	ns
CLOCK PERIOD	$PW_{CLK}^{(2)}$	66.7	—	—	ns
CLOCK PULSE HIGH PERIOD	$PWH^{(2)}$	26.7	—	—	ns
CLOCK PULSE LOW PERIOD	$PWL^{(2)}$	26.7	—	—	ns
HSYNC SETUP TIME	$t_{hs}$	10	—	—	ns
HSYNC HOLD TIME	$t_{hh}$	10	—	—	ns
DATA SETUP TIME	$t_{ds}$	10	—	—	ns
DATA HOLD TIME	$t_{dh}$	10	—	—	ns
DE SETUP TIME	$t_{des}$	10	—	—	ns
DE HOLD TIME	$t_{deh}$	10	—	—	ns
VSYNC SETUP TIME	$t_{vhs}$	10	—	—	ns
VSYNC HOLD TIME	$t_{vhh}$	10	—	—	ns

NOTE : 1. TR, TF IS DEFINED 10% TO 90% OF SIGNAL AMPLITUDE.  
2. FOR PARALLEL INTERFACE, MAXIMUM CLOCK FREQUENCY IS 15MHZ.



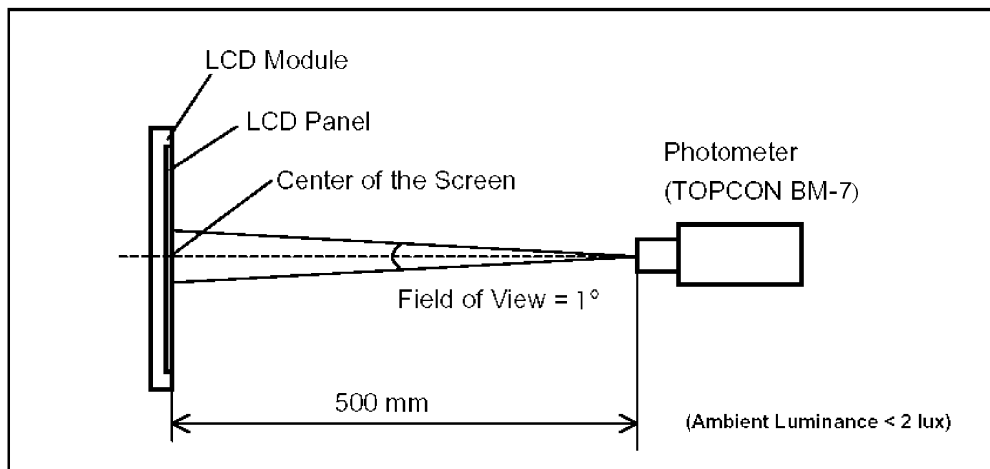
6. OPTICAL CHARACTERISTICS (NOTE 1)  
6.1 OPTICAL CHARACTERISTICS

Ta = 25°C

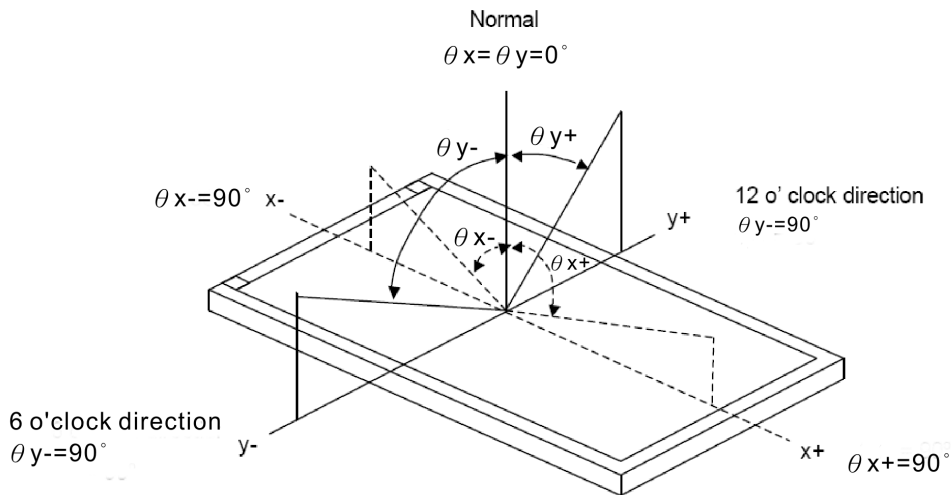
I T E M		SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
VIEWING ANGLE		$\theta_{y+}$	CR $\geq$ 10	50	55	—	deg.	(2) (3)
		$\theta_{y-}$		70	75	—		
		$\theta_{x+}$		70	75	—		
		$\theta_{x-}$		70	75	—		
CONTRAST RATIO		CR	$\theta_x=0^\circ, \theta_y=0^\circ$	300	—	—	—	(3)
RESPONSE TIME		tr (rise)	$\theta_x=0^\circ, \theta_y=0^\circ$	—	5	—	msec	(4)
		tf (fall)		—	15	—		
THE BRIGHTNESS OF MODULE		B	$\theta_x=0^\circ, \theta_y=0^\circ$ IF = 36mA	400	—	—	cd/m <sup>2</sup>	(5)
COLOR OF CIE COORDINATE	WHITE	Wx	$\theta_x=0^\circ, \theta_y=0^\circ$ IF = 36mA NTSC : 50%	0.27	0.32	0.37	—	(6)
		Wy		0.295	0.345	0.395		
	RED	Rx		0.56	0.59	0.62	—	
		Ry		0.305	0.34	0.375		
	GREEN	Gx		0.3	0.33	0.36	—	
		Gy		0.555	0.59	0.625		
	BLUE	Bx		0.115	0.145	0.175	—	
		By		0.075	0.11	0.145		
THE BRIGHTNESS OF UNIFORMITY		—	$\theta_x=0^\circ, \theta_y=0^\circ$ IF = 36mA	70	75	—	%	(5)

NOTE (1) : TEST EQUIPMENT SETUP :

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES, THE MEASUREMENT SHOULD BE EXECUTED. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 1° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.



NOTE (2) : DEFINITION OF VIEWING ANGLE :

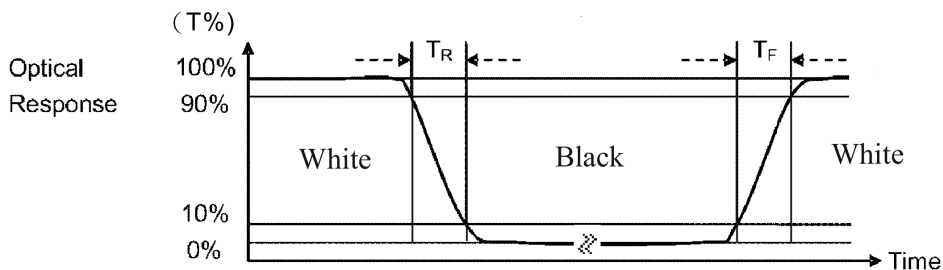


NOTE (3) : DEFINITION OF CONTRAST RATIO :

$$\text{CONTRAST RATIO(CR)} = \frac{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"}}{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "BLACK STATE"}}$$

NOTE (4) : DEFINITION OF RESPONSE TIME : TR AND TF

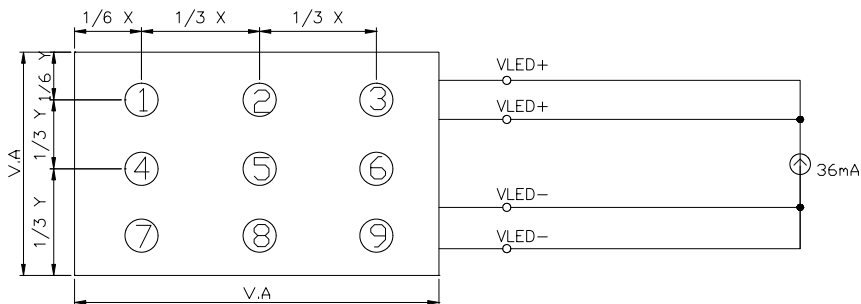
THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



NOTE (5) : MEASURED AT THE CENTER AREA OF THE PANEL WHEN ALL THE INPUT TERMINALS OF LCD PANEL ARE ELECTRICALLY OPENED.

NOTE (6) : THE 100% TRANSMISSION IS DEFINED AS THE TRANSMISSION OF LCD PANEL WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY OPENED.

### 6.2 THE BRIGHTNESS TEST METHOD

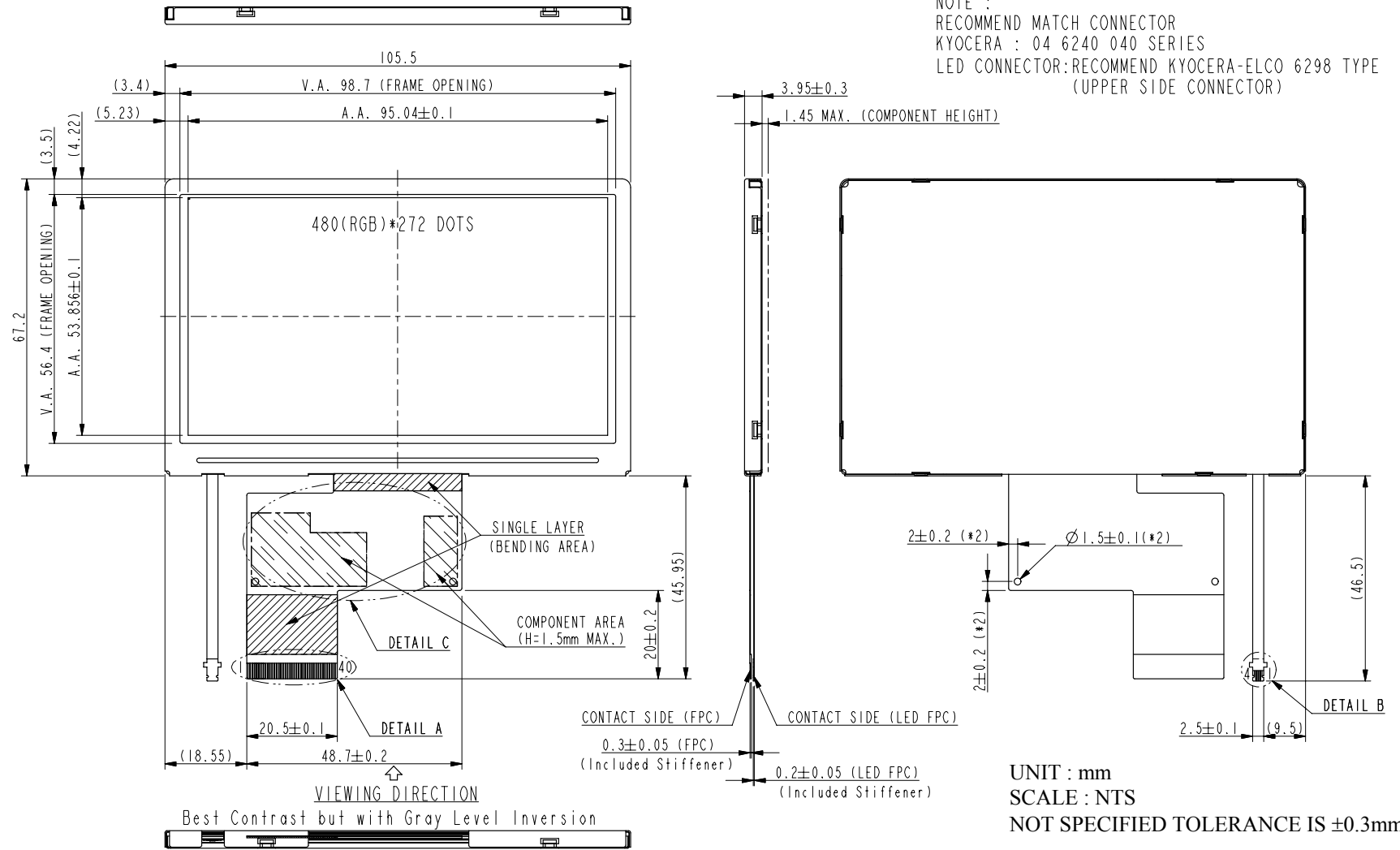


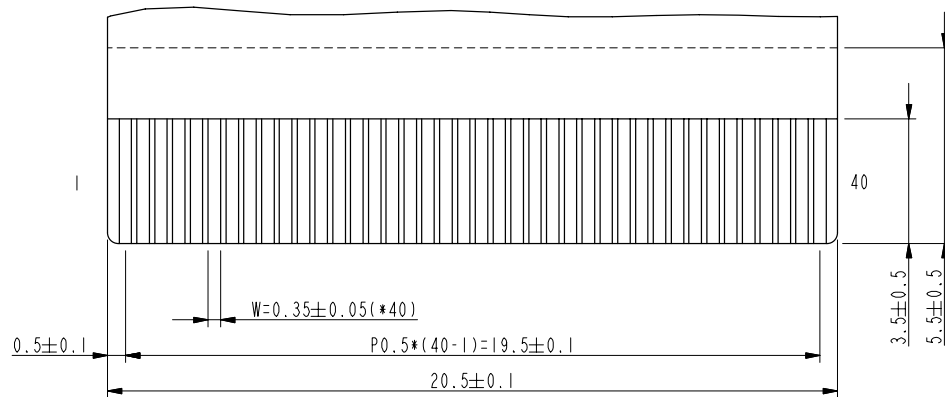
UNIT : mm

### 6.3 THE BRIGHTNESS UNIFORMITY CALCULATE METHOD

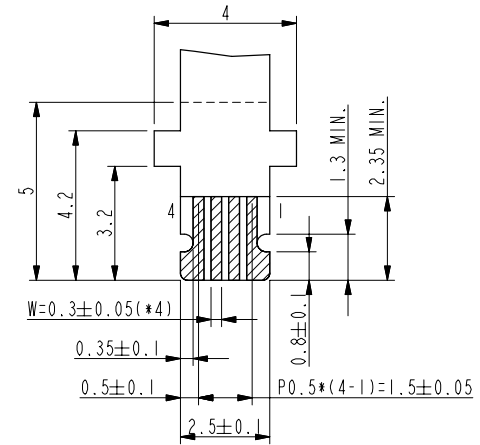
$$\text{UNIFORMITY} : \left[ 1 - \frac{\text{MAXIMUM BRIGHTNESS} - \text{MINIMUM BRIGHTNESS}}{\text{AVERAGE BRIGHTNESS}} \right] \times 100\%$$

7. OUTLINE DIMENSIONS

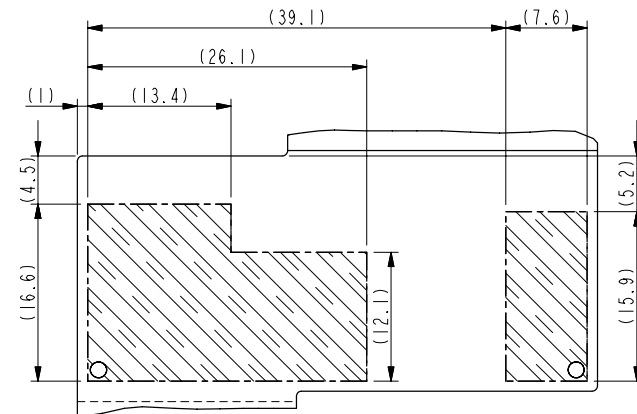




DETAIL A  
SCALE 5:1

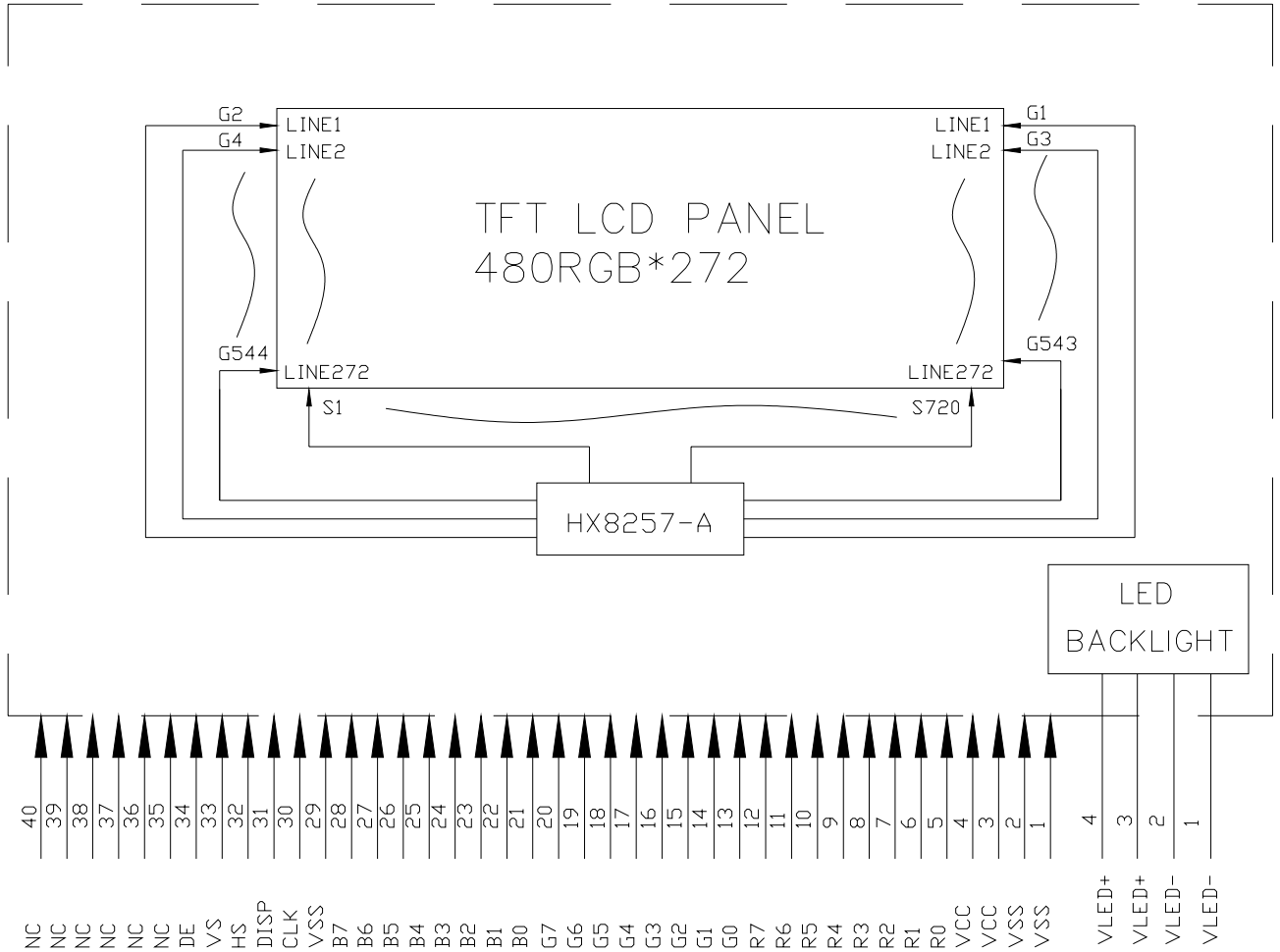


DETAIL B  
SCALE 5:1



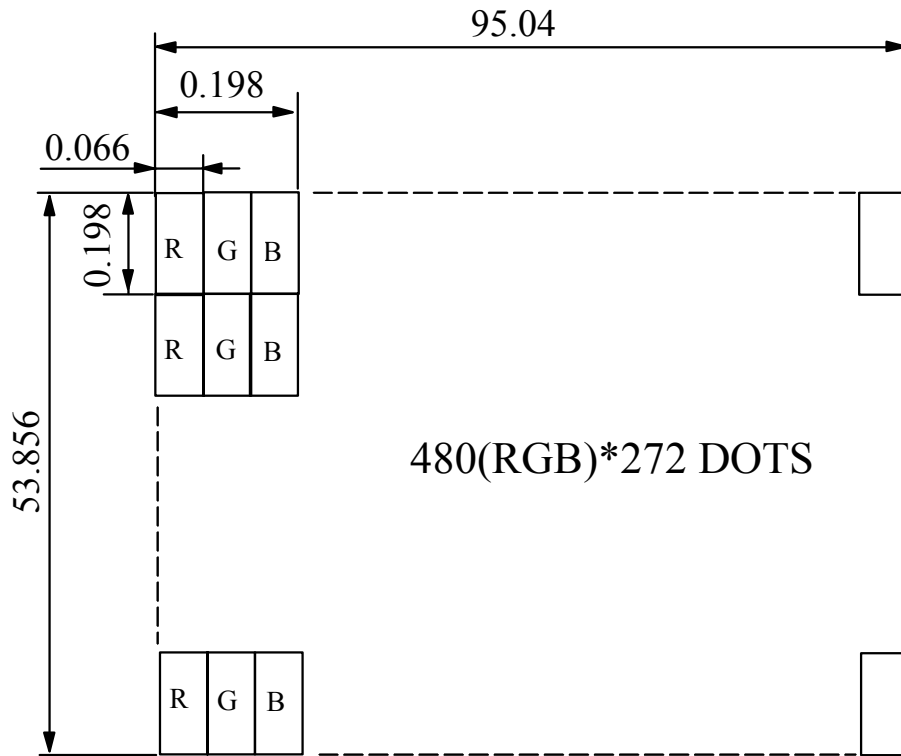
DETAIL C  
SCALE 3:2

8. BLOCK DIAGRAM





9. DETAIL DRAWING OF DOT MATRIX



UNIT : mm  
 SCALE : NTS  
 NOT SPECIFIED TOLERANCE IS  $\pm 0.1$   
 DOTS MATRIX TOLERANCE IS  $\pm 0.01$

10. INTERFACE SIGNALS

10.1 LCM INTERFACE

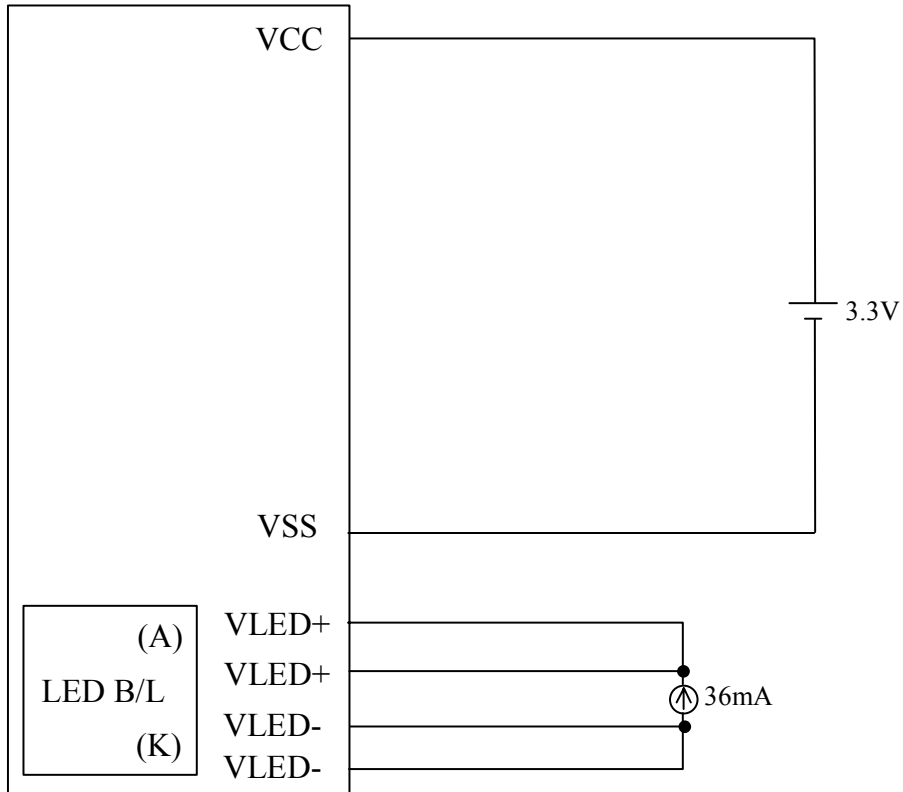
PIN NO	SYMBOL	FUNCTION
1	VSS	GROUND
2	VSS	GROUND
3	VCC	+3.3V POWER SOURCE
4	VCC	+3.3V POWER SOURCE
5	R0	RED DATA SIGNAL (LSB)
6	R1	RED DATA SIGNAL
7	R2	RED DATA SIGNAL
8	R3	RED DATA SIGNAL
9	R4	RED DATA SIGNAL
10	R5	RED DATA SIGNAL
11	R6	RED DATA SIGNAL
12	R7	RED DATA SIGNAL (MSB)
13	G0	GREEN DATA SIGNAL (LSB)
14	G1	GREEN DATA SIGNAL
15	G2	GREEN DATA SIGNAL
16	G3	GREEN DATA SIGNAL
17	G4	GREEN DATA SIGNAL
18	G5	GREEN DATA SIGNAL
19	G6	GREEN DATA SIGNAL
20	G7	GREEN DATA SIGNAL (MSB)
21	B0	BLUE DATA SIGNAL (LSB)
22	B1	BLUE DATA SIGNAL
23	B2	BLUE DATA SIGNAL
24	B3	BLUE DATA SIGNAL
25	B4	BLUE DATA SIGNAL
26	B5	BLUE DATA SIGNAL
27	B6	BLUE DATA SIGNAL
28	B7	BLUE DATA SIGNAL (MSB)
29	VSS	GROUND
30	CLK	CLOCK SIGNAL FOR DATA LATCHING AND INTERNAL COUNTER OF THE TIMING CONTROLLER.
31	DISP	DISPLAY ON/OFF MODE CONTROL. INTERNALLY PULLED HIGH. (a) DISP=L, STANDBY MODE. (b) DISP=H, NORMAL DISPLAY MODE.
32	HS	HORIZONTAL SYNC INPUT WITH NEGATIVE POLARITY. INTERNALLY PULL HIGH.

PIN NO	SYMBOL	FUNCTION
33	VS	VERTICAL SYNC INPUT WITH NEGATIVE POLARITY. INTERNALLY PULL HIGH.
34	DE	INPUT DATA ENABLE CONTROL. INTERNALLY PULLED LOW.
35	NC	NC
36	NC	NC
37	NC	NC
38	NC	NC
39	NC	NC
40	NC	NC

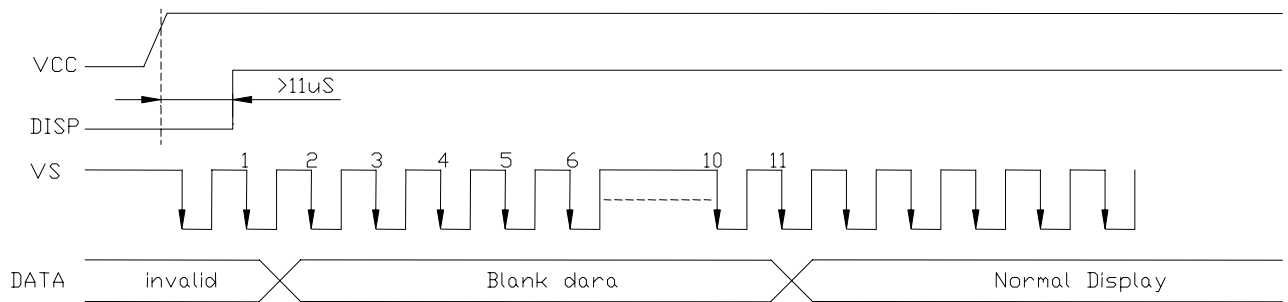
10.2 LED B/L INTERFACE

PIN NO	SYMBOL	FUNCTION
1	VLED-	LED POWER SOURCE INPUT TERMINAL (CATHODE SIDE)
2	VLED-	LED POWER SOURCE INPUT TERMINAL (CATHODE SIDE)
3	VLED+	LED POWER SOURCE INPUT TERMINAL (ANODE SIDE)
4	VLED+	LED POWER SOURCE INPUT TERMINAL (ANODE SIDE)

11. POWER SUPPLY  
11.1 POWER SUPPLY FOR LCM



11.2 POWER ON SEQUENCE



12. INSPECTION CRITERION

12.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.( E.D.T ) TO CUSTOMERS

12.2 INSPECTION CONDITIONS

12.2.1 (1)OBSERVATION DISTANCE : 35cm±5cm

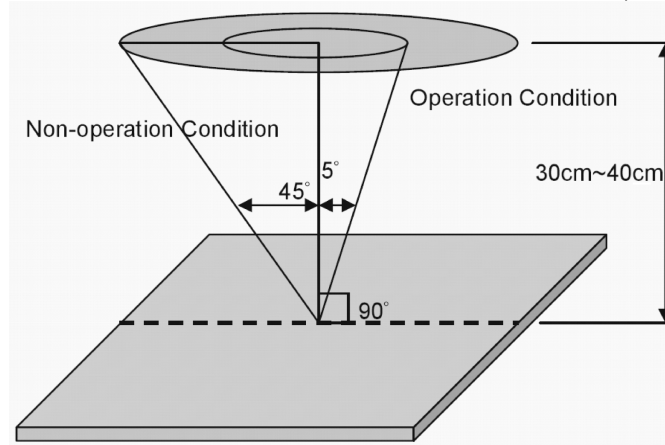
(2)VIEW ANGLE :

NON-OPERATION CONDITION : ±5°

(PERPENDICULAR TO LCD PANEL SURFACE)

OPERATION CONDITION : ±45°

(PERPENDICULAR TO LCD PANEL SURFACE)



12.2.2 ENVIRONMENT CONDITIONS :

AMBIENT TEMPERATURE		20°C~25°C
AMBIENT HUMIDITY		65±20%RH
AMBIENT ILLUMINATION	COSMETIC INSPECTION	MORE THAN 600Lux
	FUNCTIONAL INSPECTION	300~500 Lux

12.2.3 INSPECTION LOT

QUANTITY PER DELIVERY LOT FOR EACH MODEL

12.2.4 INSPECTION METHOD

A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY

(a)APPLICABLE STANDARD :

MIL-STD-105E

NORMAL INSPECTION, SINGLE SAMPLING

LEVEL II

(b)AQL : MAJOR DEFECT : AQL 0.65

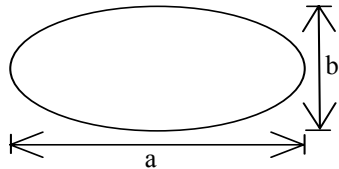
MINOR DEFECT : AQL 1.0

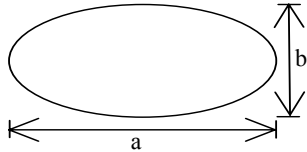
12.3 INSPECTION STANDARDS

12.3.1 VISUAL DEFECTS CLASSIFICATION

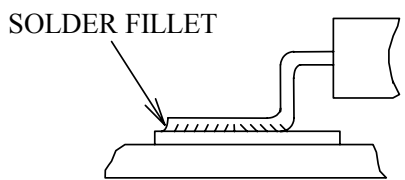
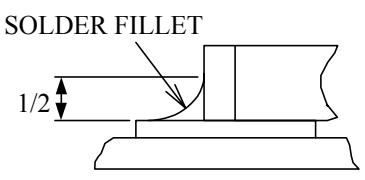
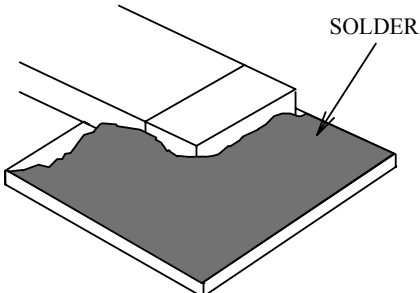
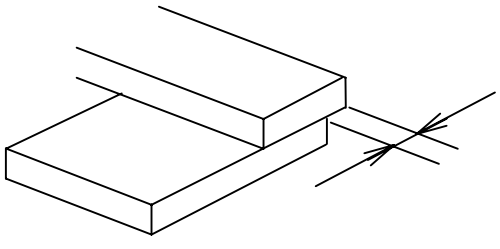
TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
MAJOR DEFECT	1.DISPLAY ON	<ul style="list-style-type: none"> <li>• DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS</li> <li>EX: DISCONNECTION, SHORT CIRCUIT ETC</li> </ul>	0.65
	2.BACKLIGHT	<ul style="list-style-type: none"> <li>• NO LIGHT</li> <li>• FLICKERING AND OTHER ABNORMAL ILLUMINATION</li> </ul>	
	3.DIMENSIONS	<ul style="list-style-type: none"> <li>• SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS</li> </ul>	
MINOR DEFECT	1.DISPLAY ZONE	<ul style="list-style-type: none"> <li>• BLACK/WHITE SPOT</li> <li>• BUBBLES ON POLARIZER</li> <li>• NEWTON RING</li> <li>• BLACK/WHITE LINE</li> <li>• SCRATCH</li> <li>• CONTAMINATION</li> <li>• LEVER COLOR SPREAD</li> </ul>	1.0
	2.BEZEL ZONE	<ul style="list-style-type: none"> <li>• STAINS</li> <li>• SCRATCHES</li> <li>• FOREIGN MATTER</li> </ul>	
	3.SOLDERING	<ul style="list-style-type: none"> <li>• INSUFFICIENT SOLDER</li> <li>• SOLDERED IN INCORRECT POSITION</li> <li>• CONVEX SOLDERING SPOT</li> <li>• SOLDER BALLS</li> <li>• SOLDER SCRAPS</li> </ul>	
	4.DISPLAY ON (ALL ON)	<ul style="list-style-type: none"> <li>• LIGHT LINE</li> </ul>	

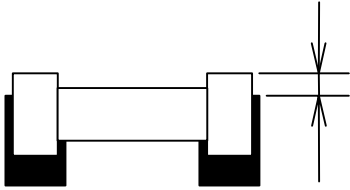
12.3.2 MODULE DEFECTS CALSSIFICATION

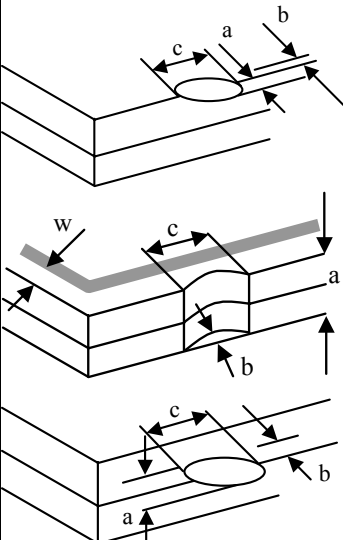
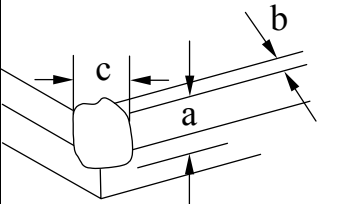
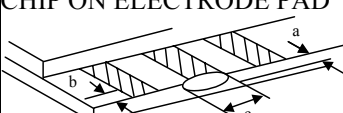
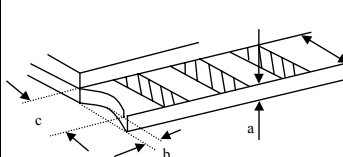
NO.	ITEM	CRITERIA												
1.	DISPLAY ON INSPECTION	(1)INCORRECT PATTERN (2)MISSING SEGMENT (3)DIM SEGMENT (4)OPERATING VOLTAGE BEYOND SPEC												
2.	OVERALL DIMENSIONS	(1)OVERALL DIMENSION BEYOND SPEC												
3.	DOT DEFECT	(1) INSPECTION PATTERN: FULL WHITE, FULL BLACK, RED, GREEN AND BLUE SCREENS. (2) <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>ITEMS</th> <th>ACCEPTABLE COUNT</th> </tr> </thead> <tbody> <tr> <td>BRIGHT DOT</td> <td>N ≤ 2</td> </tr> <tr> <td>DARK DOT</td> <td>N ≤ 3</td> </tr> <tr> <td>TOAL BRIGHT AND DARK DOTS</td> <td>N ≤ 4</td> </tr> </tbody> </table> <p>NOTE :</p> <p>1. THE DEFINITION OF DOT : THE SIZE OF A DEFECTIVE DOT OVER 1/2 OF WHOLE DOT IS REGARDED AS ONE DEFECTIVE DOT.</p> <p>2. BRIGHT DOT : DOTS APPEAR BRIGHT AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER BLACK PATTERN.</p> <p>3. DARK DOT : DOTS APPEAR DARK AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER PURE RED, GREEN, BLUE PICTURE.</p>	ITEMS	ACCEPTABLE COUNT	BRIGHT DOT	N ≤ 2	DARK DOT	N ≤ 3	TOAL BRIGHT AND DARK DOTS	N ≤ 4				
ITEMS	ACCEPTABLE COUNT													
BRIGHT DOT	N ≤ 2													
DARK DOT	N ≤ 3													
TOAL BRIGHT AND DARK DOTS	N ≤ 4													
4.	FOREIGN BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA	<table border="1" style="margin-left: 20px;"> <thead> <tr> <th>LENGTH : L</th> <th>WIDTH : W</th> <th>PERMISSIBLE NO.</th> </tr> </thead> <tbody> <tr> <td><math>L \leq 0.3</math></td> <td><math>W \leq 0.05</math></td> <td>IGNORE</td> </tr> <tr> <td><math>0.3 &lt; L \leq 2.5</math></td> <td><math>0.05 &lt; W \leq 0.1</math></td> <td>4</td> </tr> <tr> <td><math>2.5 &lt; L</math></td> <td><math>0.1 &lt; W</math></td> <td>NONE</td> </tr> </tbody> </table> <p>WIDTH : W mm, LENGH : L mm</p>	LENGTH : L	WIDTH : W	PERMISSIBLE NO.	$L \leq 0.3$	$W \leq 0.05$	IGNORE	$0.3 < L \leq 2.5$	$0.05 < W \leq 0.1$	4	$2.5 < L$	$0.1 < W$	NONE
LENGTH : L	WIDTH : W	PERMISSIBLE NO.												
$L \leq 0.3$	$W \leq 0.05$	IGNORE												
$0.3 < L \leq 2.5$	$0.05 < W \leq 0.1$	4												
$2.5 < L$	$0.1 < W$	NONE												
5.	FOREIGN MATTER \ BLACK SPOTS \ WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)	<table border="1" style="margin-left: 20px;"> <thead> <tr> <th>AVERAGE DIAMETER (mm): D</th> <th>NUMBER OF PIECES PERMITTED</th> </tr> </thead> <tbody> <tr> <td><math>D \leq 0.15</math></td> <td>IGNORE</td> </tr> <tr> <td><math>0.15 &lt; D \leq 0.5</math></td> <td>4</td> </tr> <tr> <td><math>0.5 &lt; D</math></td> <td>NONE</td> </tr> </tbody> </table> <p>NOTE : DIAMETER <math>D=(a+b)/2</math></p> 	AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED	$D \leq 0.15$	IGNORE	$0.15 < D \leq 0.5$	4	$0.5 < D$	NONE				
AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED													
$D \leq 0.15$	IGNORE													
$0.15 < D \leq 0.5$	4													
$0.5 < D$	NONE													

NO.	ITEM	CRITERIA		
			AVERAGE DIAMETER (mm) : D	NUMBER OF PIECES PERMITTED
6.	BUBBLES OF POLARIZER /DIRT/CF FAIL /SURFACE STAINS	BUBBLE ON THE POLARIZER	$D \leq 0.25$	IGNORE
			$0.25 < D \leq 0.5$	$N \leq 5$
			$0.5 < D$	NOTE
		SURFACE STATUS	$D < 0.1 \text{ mm}$	IGNORE
			$0.1 < D \leq 0.3 \text{ mm}$	$N \leq 3$
		CF FAIL / SPOT	$D < 0.1 \text{ mm}$	IGNORE
$0.1 < D \leq 0.3 \text{ mm}$	$N \leq 3$			
		<p>NOTE : (1)POLARIZER BUBBLE IS DEFINED AS THE BUBBLE APPEARS ON ACTIVE DISPLAY AREA. THE DEFECT OF POLARIZER BUBBLE SHALL BE IGNORED IF THE POLARIZER BUBBLE APPEARS ON THE OUTSIDE OF ACTIVE DISPLAY AREA.</p> <p>(2)THE EXTRANEIOUS SUBSTANCE IS DEFINED AS IT CAN BE OBSERVED WHEN THE MODULE IS POWER ON.</p> <p>(3)THE DEFINITION OF AVERAGE DIAMETER, D IS DEFINED AS FOLLOWING.</p> <p>AVERAGE DIAMETER (D)=(a+b)/2</p> 		
7.	LINE DEFECT ON DISPLAY	OBVIOUS VERTICAL OR HORIZONTAL LINE DEFECT IS NOT ALLOW		
8.	MURA ON DISPLAY	IT'S OK IF MURA IS SLIGHT VISIBLE THROUG 6% ND FILTER		
9.	UNEVEN COLOR SPREAD, COLORATION	(1)TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.		
10.	BEZEL APPEARANCE	(1)BEZEL MAY NOT HAVE RUST, BE DEFORMED OR HAVE FINGER PRINTS STAINS OF OTHER CONTAMINATION. (2)BEZEL MUST COMPLY WITH JOB SPECIFICATIONS.		
11	PCB	<p>(1)THERE MAY NOT BE MORE THAN 2mm OF SEALANT OUTSIDE THE SEAL AREA ON THE PCB, AND THERE SHOULD BE NO MORE THAN THREE PLACES.</p> <p>(2)NO OXIDATION OR CONTAMINATION PCB TERMINALS.</p> <p>(3)PARTS ON PCB MUST BE THE SAME AS ON THE PRODUCTION CHARACTERISTIC CHART. THERE SHOULD BE NO WRONG PARTS, MISSING PARTS OR EXCESS PARTS.</p> <p>(4)THE JUMPER ON THE PCB SHOULD CONFORM TO THE PRODUCT CHARACTERISTIC CHART.</p> <p>(5)IF SOLDER GETS ON BEZEL TAB PADS, LED PAD, ZEBRA PAD OR SCREW HOLD PAD; MAKE SURE IT IS SMOOTHED DOWN.</p>		



NO.	ITEM	CRITERIA
12.	SOLDERING	<p>(1)NO SOLDERING FOUND ON THE SPECIFIED PLACE</p> <p>(2)INSUFFICIENT SOLDER</p> <p>(a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD</p>  <p>(b)CHIP COMPONENT • SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING</p>  <p>• SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED</p>  <p>(3)PARTS ALIGMENT</p> <p>(a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE</p> 

NO.	ITEM	CRITERIA
12.	SOLDERING	<p>(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE</p>  <p>(4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB.  (5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE.  (6)NO RESIDUE OR SOLDER BALLS ON PCB.  (7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.</p>
13.	BACKLIGHT	<p>(1)NO LIGHT  (2)FLICKERING AND OTHER ABNORMAL ILLUMINATION  (3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS.  (4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.</p>
14.	GENERAL APPEARANCE	<p>(1)NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP.  (2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP.  (3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT.  (4)THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS.  (5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER.  (6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR.  (7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED.  (8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET.  (9)LCD PIN LOOSE OR MISSING PINS.  (10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET.  (11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET.  (12)THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK.</p>

NO.	ITEM	CRITERIA										
15.	CRACKED GLASS	THE LCD WITH EXTENSIVE CRACK IS NOT ACCEPTABLE										
		<p>GENERAL GLASS CHIP :</p> 	<table border="1" data-bbox="933 421 1455 497"> <thead> <tr> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td><math>\leq t/2</math></td> <td>&lt; VIEWING AREA</td> <td><math>\leq 1/8X</math></td> </tr> <tr> <td><math>t/2 &gt;, \leq 2t</math></td> <td><math>\leq W/2</math></td> <td><math>\leq 1/8X</math></td> </tr> </tbody> </table> <p>*W=DISTANCE BETWEEN SEALANT AREA AND LCD PANEL EDGE X = LCD SIDE LENGTH t = GLASS THICKNESS</p>	a	b	c	$\leq t/2$	< VIEWING AREA	$\leq 1/8X$	$t/2 >, \leq 2t$	$\leq W/2$	$\leq 1/8X$
		a	b	c								
		$\leq t/2$	< VIEWING AREA	$\leq 1/8X$								
		$t/2 >, \leq 2t$	$\leq W/2$	$\leq 1/8X$								
<p>CORNER PART :</p> 	<table border="1" data-bbox="933 1003 1455 1079"> <thead> <tr> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td><math>\leq t/2</math></td> <td>&lt; VIEWING AREA</td> <td><math>\leq 1/8X</math></td> </tr> <tr> <td><math>&gt; t/2, \leq 2t</math></td> <td><math>\leq W/2</math></td> <td><math>\leq 1/8X</math></td> </tr> </tbody> </table> <p>*W=DISTANCE BETWEEN SEALANT AREA AND LCD PANEL EDGE X = LCD SIDE LENGTH t = GLASS THICKNESS</p>	a	b	c	$\leq t/2$	< VIEWING AREA	$\leq 1/8X$	$> t/2, \leq 2t$	$\leq W/2$	$\leq 1/8X$		
a	b	c										
$\leq t/2$	< VIEWING AREA	$\leq 1/8X$										
$> t/2, \leq 2t$	$\leq W/2$	$\leq 1/8X$										
<p>CHIP ON ELECTRODE PAD</p> 	<table border="1" data-bbox="933 1272 1455 1326"> <thead> <tr> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td><math>\leq t</math></td> <td><math>\leq 0.5\text{mm}</math></td> <td><math>\leq 1/8X</math></td> </tr> </tbody> </table> <p>* X=LCD SIDE WIDTH t=GLASS THICKNESS</p>	a	b	c	$\leq t$	$\leq 0.5\text{mm}$	$\leq 1/8X$					
a	b	c										
$\leq t$	$\leq 0.5\text{mm}$	$\leq 1/8X$										
	<table border="1" data-bbox="933 1429 1455 1482"> <thead> <tr> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td><math>\leq t</math></td> <td><math>\leq 1/8X</math></td> <td><math>\leq L</math></td> </tr> </tbody> </table> <p>*X=LCD SIDE WIDTH t = GLASS THICKNESS L=ELECTRODE PAD LENGTH ①IF GLASS CHIPPING THE ITO TERMINAL, OVER 2/3 OF THE ITO MUST REMAIN AND BE, INSPECTED ACCORDING TO ELECTRODE TERMINAL SPECIFICATIONS ②IF THE PRODUCT WILL BE HEAT SEALED BY THE CUSTOMER, THE ALIGNMENT MARK MUST NOT BE DAMAGED</p>	a	b	c	$\leq t$	$\leq 1/8X$	$\leq L$					
a	b	c										
$\leq t$	$\leq 1/8X$	$\leq L$										

12.4 RELIABILITY TEST

12.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO	ITEM	DESCRIPTION
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS
4	LOW TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS
5	HIGH TEMP / HUMIDITY TEST STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS
6	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION: -40°C FOR 30 MINUTES ~ +80°C FOR 30 MINUTES
7	ESD (ELECTROSTATIC DISCHARGE) (NOT OPERATED)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV

NOTE (1) : THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

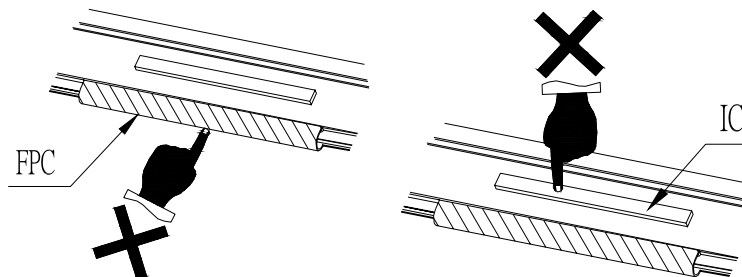
12.5 TESTING CONDITIONS AND INSPECTION CRITERIA

FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 12.5, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION	REFER TO SPECIFICATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO SPECIFICATION	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

12.6 OPERATION

- 12.6.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 12.6.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE ; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY ; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR . WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 12.6.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST .
- 12.6.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE.  
IF ABOVE SEQUENCE IS NOT FOLLOWED , CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH - UP PROBLEM.
- 12.6.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!  
DO NOT STRESS FPC AND IC ON THE MODULE!



12.7 NOTICE

- 12.7.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD .
- 12.7.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED.
- 12.7.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 12.7.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE ; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 12.7.5 DON'T GIVE EXTERNAL SHOCK.
- 12.7.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 12.7.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.  
WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC. WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 12.7.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 12.7.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 12.7.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 12.7.11 REWIRING: NO MORE THAN 3 TIMES.

Our company network supports you worldwide with offices in Germany, Austria, Switzerland, the UK and the USA. For more information please contact:

## Headquarters

Germany



**FORTEC Elektronik AG**

Lechwiesenstr. 9  
86899 Landsberg am Lech

Phone: +49 8191 91172-0  
E-Mail: [sales@forteca.de](mailto:sales@forteca.de)  
Internet: [www.forteca.de](http://www.forteca.de)

## Fortec Group Members

Austria



**FORTEC Elektronik AG**

**Office Vienna**

Nuschinggasse 12  
1230 Wien

Phone: +43 1 8673492-0  
E-Mail: [office@fortec.at](mailto:office@fortec.at)  
Internet: [www.fortec.at](http://www.fortec.at)

Germany



**Distec GmbH**

Augsburger Str. 2b  
82110 Germering

Phone: +49 89 894363-0  
E-Mail: [info@distec.de](mailto:info@distec.de)  
Internet: [www.distec.de](http://www.distec.de)

Switzerland



**ALTRAC AG**

Bahnhofstraße 3  
5436 Würenlos

Phone: +41 44 7446111  
E-Mail: [info@altrac.ch](mailto:info@altrac.ch)  
Internet: [www.altrac.ch](http://www.altrac.ch)

United Kingdom



**Display Technology Ltd.**

Osprey House, 1 Osprey Court  
Hichingbrooke Business Park  
Huntingdon, Cambridgeshire, PE29 6FN

Phone: +44 1480 411600  
E-Mail: [info@displaytechnology.co.uk](mailto:info@displaytechnology.co.uk)  
Internet: [www.displaytechnology.co.uk](http://www.displaytechnology.co.uk)

USA



**Apollo Display Technologies, Corp.**

87 Raynor Avenue,  
Unit 1 Ronkonkoma,  
NY 11779

Phone: +1 631 5804360  
E-Mail: [info@apolloDisplays.com](mailto:info@apolloDisplays.com)  
Internet: [www.apolloDisplays.com](http://www.apolloDisplays.com)